

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC74AC374P, TC74AC374F, TC74AC374FT TC74AC534P, TC74AC534F

Octal D-Type Flip-Flop with 3-state Output

TC74AC374P/F/FT	Non-Inverting
TC74AC534P/F	Inverting

The TC74AC374 and TC74AC534 are advanced high speed CMOS OCTAL FLIP-FLOPS fabricated with silicon gate and double-layer metal wiring C<sup>2</sup>MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

These 8-bit D-type flip-flops are controlled by a clock input (CK) and a output enable input ( $\overline{OE}$ ).

When the  $\overline{OE}$  input is high, the eight outputs are in a high impedance state.

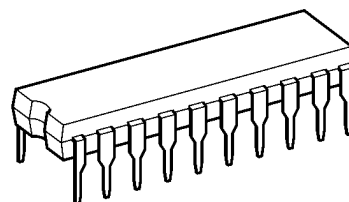
The TC74AC374 has non-inverting outputs, and TC74AC534 has inverting outputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

### Features

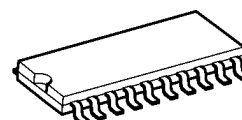
- High speed:  $f_{max} = 200$  MHz (typ.) at  $V_{CC} = 5$  V
- Low power dissipation:  $I_{CC} = 8$   $\mu$ A (max) at  $T_a = 25^\circ\text{C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\%$   $V_{CC}$  (min)
- Symmetrical output impedance:  $|I_{OH}| = I_{OL} = 24$  mA (min)  
Capability of driving 50  $\Omega$  transmission lines.
- Balanced propagation delays:  $t_{PLH} \approx t_{PHL}$
- Wide operating voltage range:  $V_{CC}$  (opr) = 2 to 5.5 V
- Pin and function compatible with 74F374/534

TC74AC374P, TC74AC534P



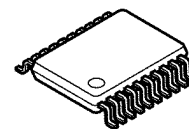
DIP20-P-300-2.54A

TC74AC374F, TC74AC534F



SOP20-P-300-1.27A

TC74AC374FT



TSSOP20-P-0044-0.65A

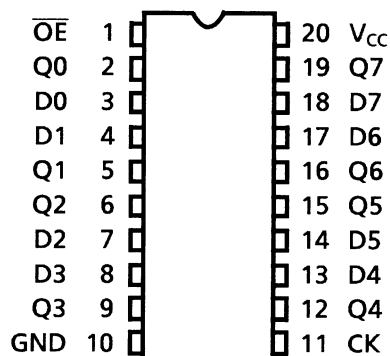
### Weight

DIP20-P-300-2.54A	: 1.30 g (typ.)
SOP20-P-300-1.27A	: 0.22 g (typ.)
TSSOP20-P-0044-0.65A	: 0.08 g (typ.)

Start of commercial production  
1986-05

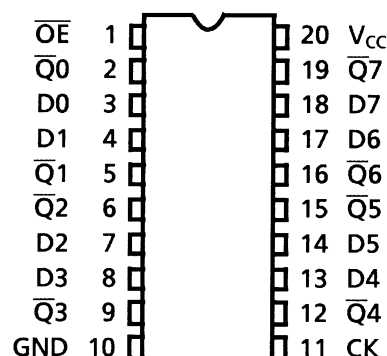
## Pin Assignment

### TC74AC374



(TOP VIEW)

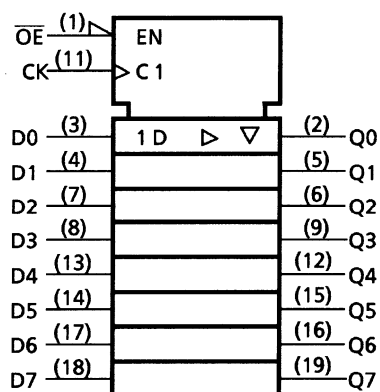
### TC74AC534



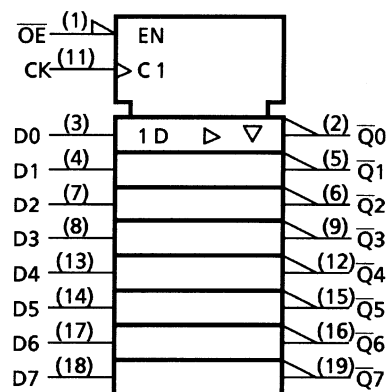
(TOP VIEW)

## IEC Logic Symbol

### TC74AC374



### TC74AC534



## Truth Table

Inputs			Outputs	
OE	CK	D	Q (374)	Q̄ (534)
H	X	X	Z	Z
L		X	Q <sub>n</sub>	Q̄ <sub>n</sub>
L		L	L	H
L		H	H	L

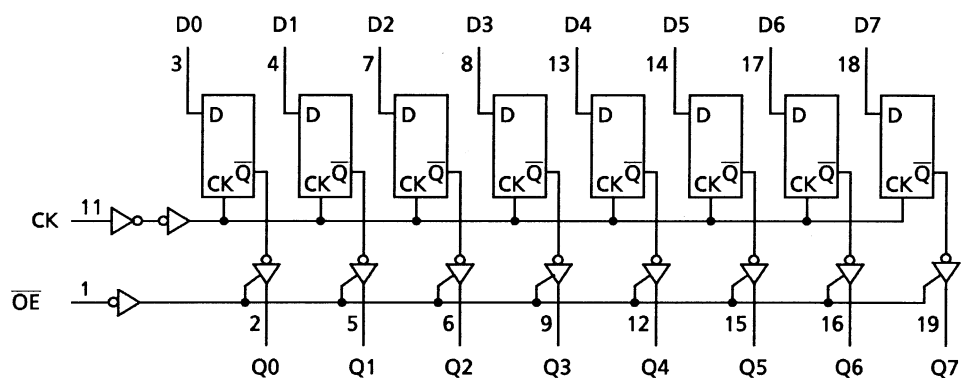
X: Don't care

Z: High impedance

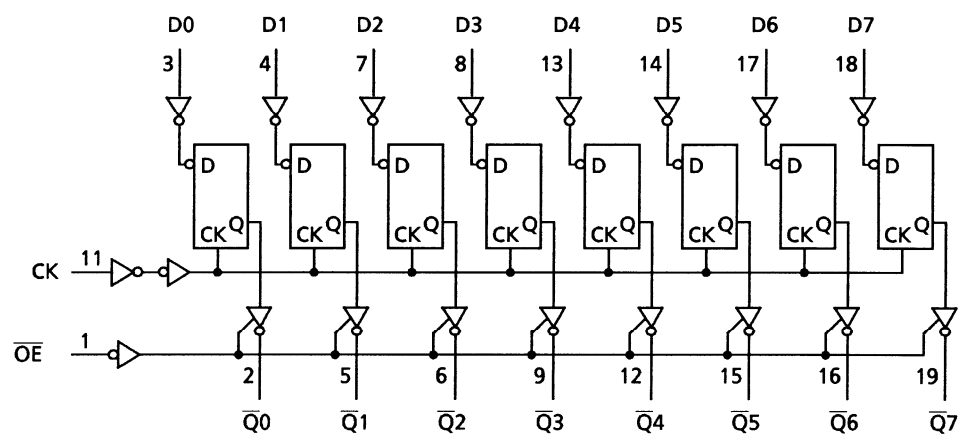
Q<sub>n</sub> (Q̄<sub>n</sub>): No change

## System Diagram

### TC74AC374



### TC74AC534



**Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	-0.5 to 7.0	V
DC input voltage	$V_{IN}$	-0.5 to $V_{CC} + 0.5$	V
DC output voltage	$V_{OUT}$	-0.5 to $V_{CC} + 0.5$	V
Input diode current	$I_{IK}$	$\pm 20$	mA
Output diode current	$I_{OK}$	$\pm 50$	mA
DC output current	$I_{OUT}$	$\pm 50$	mA
DC $V_{CC}$ /ground current	$I_{CC}$	$\pm 200$	mA
Power dissipation	$P_D$	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	$T_{stg}$	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 2: 500 mW in the range of  $T_a = -40$  to  $65^\circ\text{C}$ . From  $T_a = 65$  to  $85^\circ\text{C}$ , a derating factor of  $-10 \text{ mW}/^\circ\text{C}$  should be applied up to 300 mW.

**Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	2.0 to 5.5	V
Input voltage	$V_{IN}$	0 to $V_{CC}$	V
Output voltage	$V_{OUT}$	0 to $V_{CC}$	V
Operating temperature	$T_{opr}$	-40 to 85	°C
Input rise and fall time	$dt/dV$	0 to 100 ( $V_{CC} = 3.3 \pm 0.3 \text{ V}$ ) 0 to 20 ( $V_{CC} = 5 \pm 0.5 \text{ V}$ )	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

## Electrical Characteristics

### DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
				V <sub>CC</sub> (V)	Min	Typ.	Max	Min	Max
High-level input voltage	V <sub>IH</sub>	—		2.0 3.0 5.5	1.50 2.10 3.85	— — —	— — —	1.50 2.10 3.85	V
Low-level input voltage	V <sub>IL</sub>	—		2.0 3.0 5.5	— — —	— — —	0.50 0.90 1.65	— — —	V
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 µA	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5	— — —	1.9 2.9 4.4	V
				3.0 4.5 5.5	2.58 3.94 —	— — —	— — —	2.48 3.80 3.85	
				—	—	—	—	—	
			I <sub>OL</sub> = -4 mA	3.0	2.58	—	—	2.48	
			I <sub>OL</sub> = -24 mA	4.5	3.94	—	—	3.80	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 µA	2.0 3.0 4.5	— — —	0.0 0.0 0.0	0.1 0.1 0.1	— — —	V
				3.0 4.5 5.5	— — —	— — —	0.36 0.36 —	— — —	
				—	—	—	—	—	
			I <sub>OL</sub> = 12 mA	3.0	—	—	0.36	—	
			I <sub>OL</sub> = 24 mA	4.5	—	—	0.36	—	
3-state output off-state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5	—	—	±0.5	—	µA
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	—	—	±0.1	—	µA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	—	—	8.0	—	µA

Note: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

## Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Ta = 25°C Limit	Ta = -40 to 85°C Limit	Unit
Minimum pulse width (CK)	$t_W$ (H)	—	$3.3 \pm 0.3$	7.0	7.0	ns
	$t_W$ (L)		$5.0 \pm 0.5$	5.0	5.0	
Minimum set-up time	$t_s$	—	$3.3 \pm 0.3$	9.0	9.0	ns
			$5.0 \pm 0.5$	5.0	5.0	
Minimum hold time	$t_h$	—	$3.3 \pm 0.3$	0.0	0.0	ns
			$5.0 \pm 0.5$	0.0	0.0	

## AC Characteristics (C<sub>L</sub> = 50 pF, R<sub>L</sub> = 500 Ω, input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40 to 85°C		Unit
			V <sub>CC</sub> (V)	Min	Typ.	Max	Min	Max
Propagation delay time (CK-Q, $\bar{Q}$ )	$t_{pLH}$	—	$3.3 \pm 0.3$	—	8.5	15.8	1.0	18.0
	$t_{pHL}$		$5.0 \pm 0.5$	—	6.1	8.7	1.0	10.0
Output enable time	$t_{pZL}$	—	$3.3 \pm 0.3$	—	7.5	14.0	1.0	16.0
	$t_{pZH}$		$5.0 \pm 0.5$	—	6.1	8.7	1.0	10.0
Output disable time	$t_{pLZ}$	—	$3.3 \pm 0.3$	—	5.5	12.3	1.0	14.0
	$t_{pHZ}$		$5.0 \pm 0.5$	—	4.7	7.0	1.0	8.0
Maximum clock frequency	$f_{max}$	—	$3.3 \pm 0.3$	55	120	—	55	—
			$5.0 \pm 0.5$	100	160	—	100	—
Input capacitance	C <sub>IN</sub>	—	—	—	5	10	—	10
Output capacitance	C <sub>OUT</sub>	—	—	—	10	—	—	—
Power dissipation capacitance	C <sub>PD</sub> (Note)	—	—	—	37	—	—	—

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption

Average operating current can be obtained by the equation:

$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per F/F)}$$

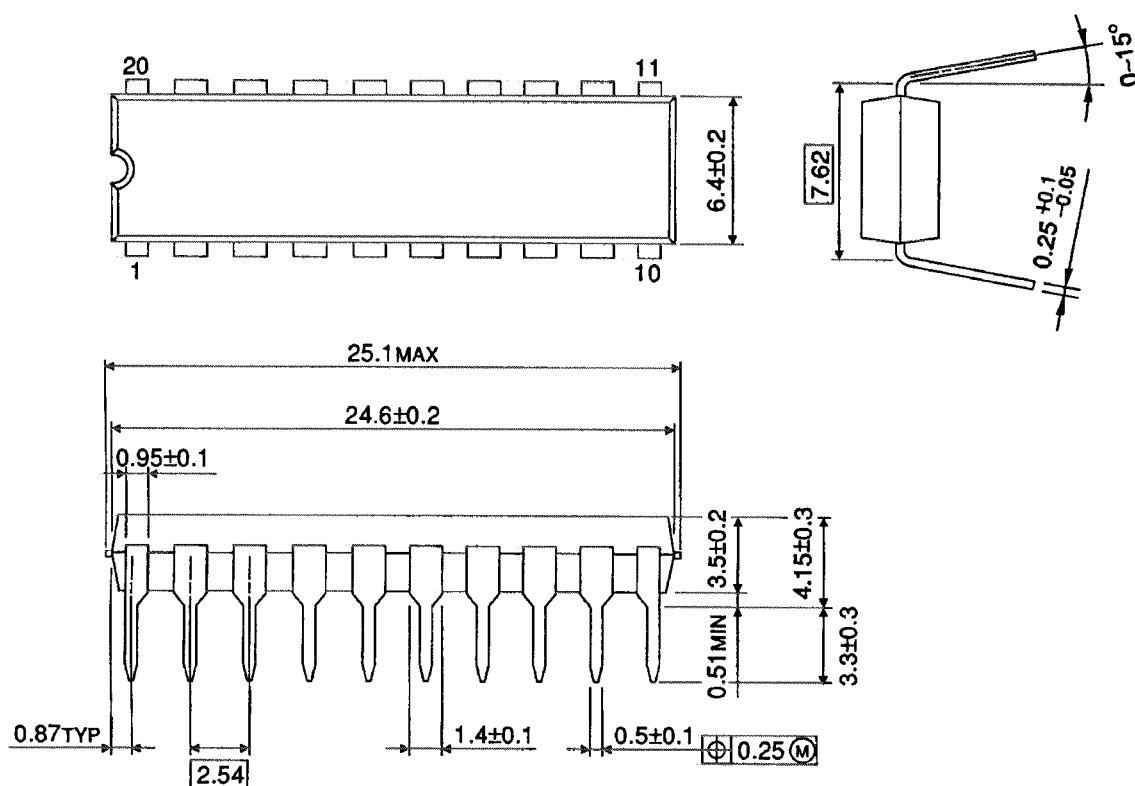
And the total C<sub>PD</sub> when n pcs. of F/F operate can be gained by the following equation:

$$C_{PD}(\text{total}) = 25 + 12 \cdot n$$

## Package Dimensions

DIP20-P-300-2.54A

Unit : mm

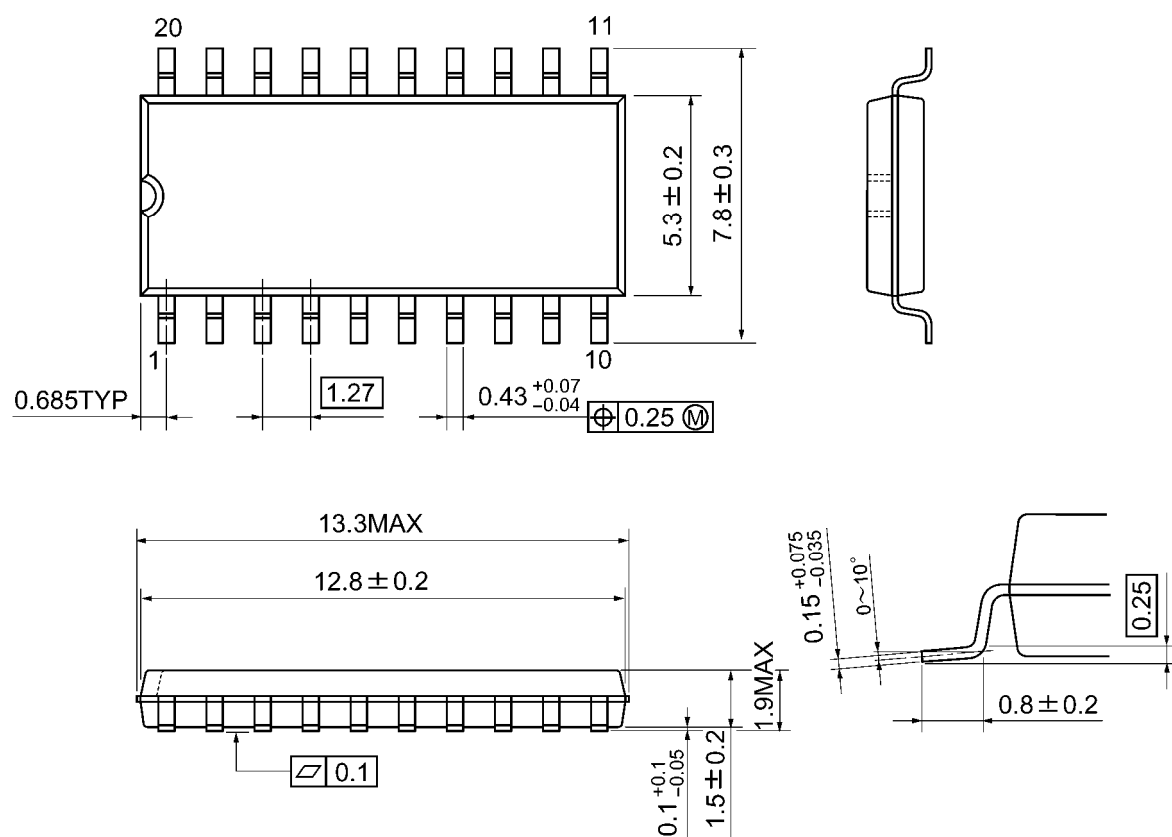


Weight: 1.30 g (typ.)

## Package Dimensions

SOP20-P-300-1.27A

Unit: mm



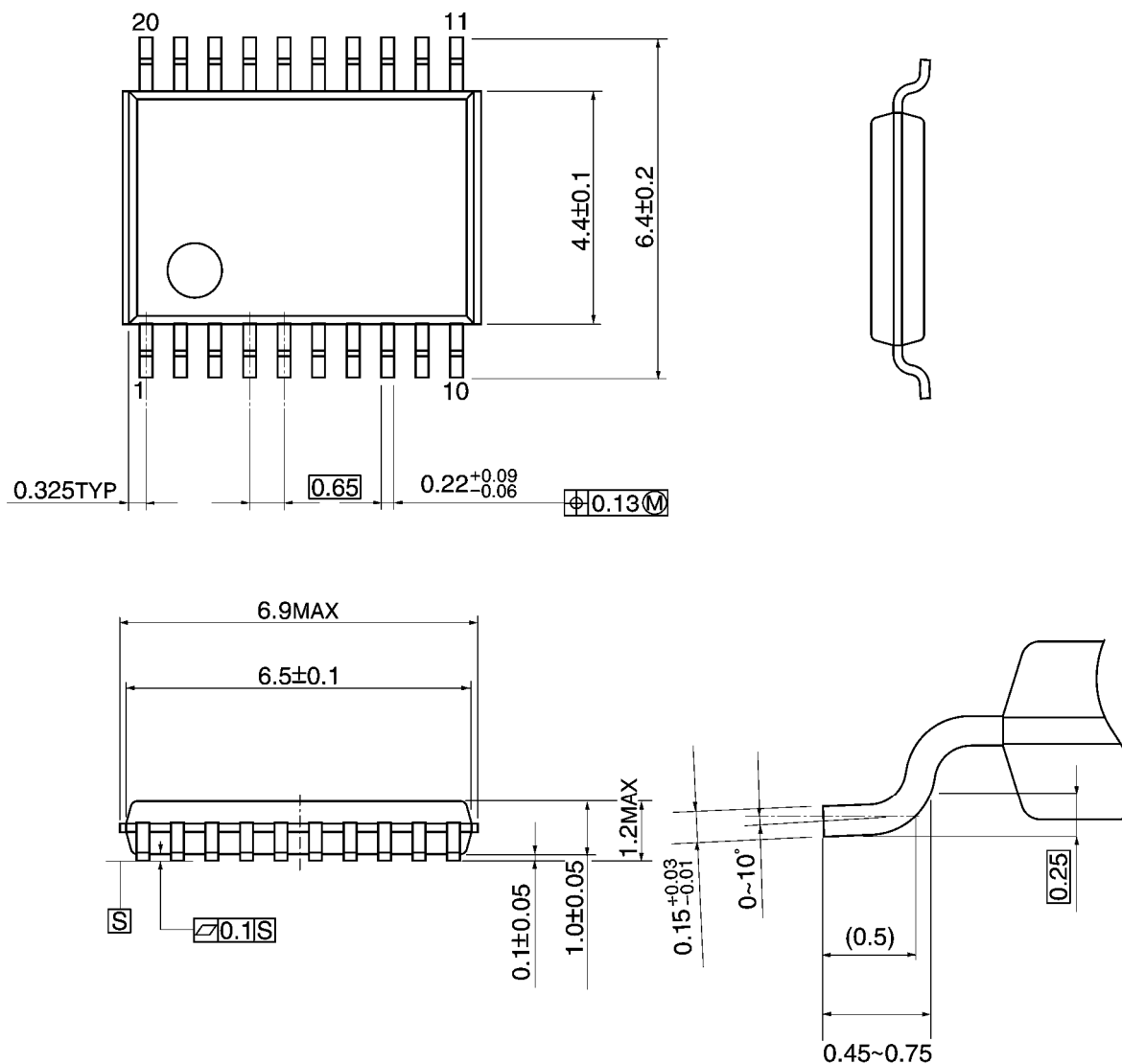
Weight: 0.22 g (typ.)



## Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm



Weight: 0.08 g (typ.)

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